TOSHIBA

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TMPN3150B1AFG

Neuron [®] Chip For Distributed Intelligent Control Networks (L_{ON}W_{ORKS}[®])

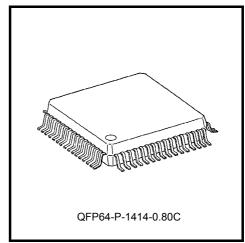
The TMPN3150B1AFG is a Neuron Chip which configures LONWORKS nodes in combination with external memory.

Neuron Chips have all the built-in communications and control functions required to implement Lonworks nodes. These nodes may then be easily integrated into highly-reliable distributed intelligent control networks.

The typical functions for this chip are explained below.

FEATURES

- I / O Functions
 - Eleven programmable I / O pins.
 - Two programmable 16-bit timers and counters built in.
 - 34 different types of I / O functions to handle a wide range of input and output.
 - ROM firmware image containing pre-programmed I / O drivers, greatly simplifying application programs.
 (Stored in external ROM)



Weight: 1.0g (Typ.)

• Network functions

- Two CPUs for communication protocol processing built in.
 The communications and application CPUs execute in parallel.
- Equipped with a built-in LonTalk protocol which supports all seven levels of the OSI reference model with ISO.
- Highly reliable communication protocol is supplied as firmware.
- Built-in twisted-pair wire transceiver
- Equipped with communications modes and communication speeds which support various types of external transceivers.
 - Supports twisted-pair wire, power line, radio (RF), infrared, coaxial cables and fiber optics.
- Communication port transceiver modes and logical addresses stored within the EEPROM.
 Can be amended via the network.

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damage to property.

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TMPN3150B1AFG



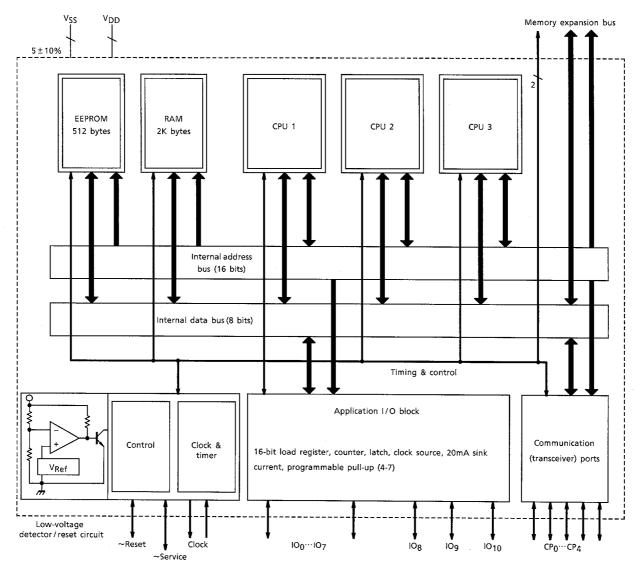
Other functions

- Application programs are also stored within the EEPROM.
 Can be updated by downloading over the network. EEPROM can be externally added.
- Built-in watch-dog timer.
- Each chip has a unique ID number. Effective during the logical installation of networks.
- Low electrical consumption mode supported with a sleep mode.
- Built-in low-voltage detection circuit.

 Prevents incorrect operations and writing errors in the EEPROM during drops in power voltage.
- The package is QFP64-P-1414-0.80C (Lead-Free Type (Pd PrePlated Frame)).

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BLOCK DIAGRAM

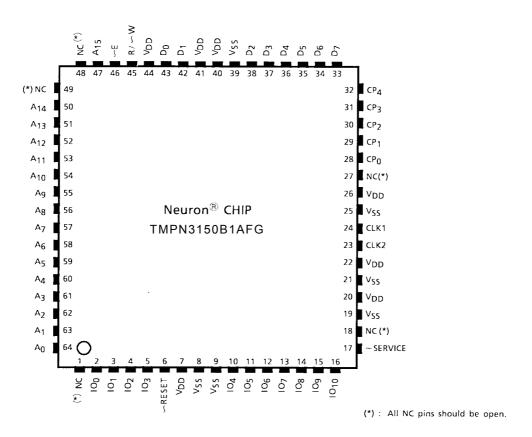


Reference clock input: 10MHz, 5MHz, 2.5MHz, 1.25MHz, 625kHz

ITEM	TMPN3150B1AFG		
CPU	8-bit CPU×3		
RAM	2,048 bytes		
ROM	_		
EEPROM	512 bytes		
16-bit Timer / Counter	2 channels		
External Memory Interface	Available		
Package	64-pin SOP		



PIN ASSIGNMENT





PIN FUNCTION

PIN No.	PIN NAME	1/0	PIN FUNCTION
24	CLK1	Input	Oscillator connection, or external clock input.
23	CLK2	Output	Oscillator connection. Leave open when external clock is input to CLK1.
6	~RESET	I / O (built-in pull-up)	Reset pin. (Active low)
17	~SERVICE	I / O (built-in configurable pull-up)	Service pin. Indicator output during operation.
2~5	IO ₀ ~IO ₃	1/0	Large current sink capacity (20mA). General I / O port.
10~13	104~107	I / O (built-in configurable pull-up)	General I / O port. One of IO_4 to IO_7 can be specified as No.1 timer / counter input. Output signal can be output to IO_0 . IO_4 can be used as the No.2 timer / counter input with IO_1 as output.
14~16	IO8~IO10	1/0	General I / O port. Can be used for serial communication with other device.
43, 42, 38~33	D ₀ , D ₁ , D ₂ ~D ₇	1/0	Data bus for memory expansion
45	R / ~W	Output	Output port for controlling read / write for memory expansion
46	~E	Output	Output port for controlling memory expansion
47, 50~64	A ₁₅ , A ₁₄ ~A ₀	Output	Address output port for memory expansion
7, 20, 22, 26, 40, 41, 44	V_{DD}	Input	Power input (5.0V Typ.)
8, 9, 19, 21, 25, 39	V _{SS}	Input	Power input (0V GND)
1, 18, 27, 48, 49	NC	_	Do not connect anything. Leave pins open.
28~32	CP ₀ ~CP ₄	1/0	Bidirectional port for communications. Supports several communications protocols by specifying mode.

 $[\]bullet$ All $V_{\mbox{\scriptsize DD}}$ terminals must be externally connected.

[•] All V_{SS} terminals must be externally connected.



MAXIMUM RATINGS ($V_{SS} = 0V, V_{SS} typ.$)

CHARACTERISTICS	SYMBOL	RATING	UNIT
Power Supply Voltage	V_{DD}	-0.3~7.0	V
Input Voltage	V _{IN}	-0.3~V _{DD} +0.3	٧
Power Dissipation	PD	800	mW
Storage Temperature	T _{stg}	-65~150	°C

OPERATING CONDITIONS

ITEM	SYMBOL	MIN	TYP.	MAX	UNIT
Operating Voltage	V_{DD}	4.5	5.0	5.5	V
Input Voltage (TTL)	V _{IH(1)}	2.0	_	V_{DD}	V
Input Voltage (TTL)	V _{IL(1)}	V _{SS}	_	0.8	V
Input Voltage (CMOS)	V _{IH(2)}	V _{DD} -0.8	_	V_{DD}	V
Input Voltage (CMOS)	V _{IL(2)}	V _{SS}	_	0.8	V
Operating Frequency	f _{osc}	0.625	_	10	MHz
Operating Temperature	T _{opr}	-40	_	85	°C

ELECTRICAL CHARACTERISTICS

DC characteristic ($V_{DD} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, Ta = $-40 \sim 85 ^{\circ}\text{C}$) (Above operating conditions apply unless otherwise states.)

CHARACTERISTICS	SYMBOL	PINS	TEST CONDITION		MIN	MAX	UNIT
LOW Output Voltage (1)	Vo. (1)	IO ₀ ~IO ₃	I _{OL} =20mA	I _{OL} =20mA		8.0	V
LOW Output Voltage (1)	V _{OL} (1)	100*103	I _{OL} =10mA	I _{OL} =10mA		0.4	V
LOW Output Voltage (2)	Vo. (2)	~SERVICE	Duty	I _{OL} =20mA	0	0.8	V
LOW Output Voltage (2)	W Output Voltage (2) V _{OL} (2) ~SERVICE	cycle=50%	I _{OL} =10mA	0	0.4	V	
LOW Output Voltage (3)	V _{OL} (3)	CP ₂ , CP ₃	I _{OL} =40mA	I _{OL} =40mA		1.0	V
LOW Output Voltage (4)	V _{OL} (4)	Others (Note 1)	I _{OL} =1.4mA		0	0.4	V
HIGH Output Voltage (1)	V _{OH} (1)	1O ₀ ~1O ₃	I _{OH} =-1.4mA		V _{DD} -0.4	V _{DD}	٧
HIGH Output Voltage (2)	V _{OH} (2)	~SERVICE	I _{OH} =-1.4mA		V _{DD} -0.4	V _{DD}	٧
HIGH Output Voltage (3)	V _{OH} (3)	CP ₂ , CP ₃	I _{OH} =-40mA		V _{DD} -1.0	V _{DD}	٧
HIGH Output Voltage (4)	V _{OH} (4)	Others (Note 1)	I _{OH} =-1.4mA		V _{DD} -0.4	V _{DD}	٧
Input Current	I _{IN}	(Note 2)	V _{IN} =V _{SS} ~V _{DD}		-10	+10	μΑ
Pull-up Current	I _{PU}	IO ₄ ~IO ₇ ~SERVICE, ~RESET (Note 3)	V _{IN} =0V		-30	-300	μΑ
Low-voltage Detection Level	V _{LVD}	V _{DD}	_		3.8	4.5	٧

Note1 : Output voltage characteristics exclude the ~RESET pin and CLK2 pin.

Note2: Excludes pull-up input pins.

Note3: The IO₄ to IO₇ and ~SERVICE pins have programmable pull-ups. ~RESET has a fixed pull-up.

ITEM		SYMBOL	TYP.	MAX	UNIT
Operating Mode Current Consumption	10 MHz Clock	IDD (OP)	18	30	mA
	5 MHz Clock		10	15	
	2.5 MHz Clock		5	8	
	1.25 MHz Clock		2.5	5	
	0.625 MHz Clock		1.5	3	
Sleep Mode Current Consumption		I _{DD (SLP)}	18	100	μΑ

Note: Test conditions for current dissipation

 V_{DD} =5V, all output=with no load, all input=0.2V or below or V_{DD} -0.2V, programmable pull-up=off, crystal oscillator clock input, differential receiver disabled.

The current value (typ.) is a typical value when Ta=25°C.

The current value (\max) applies to the rated temperature range at V_{DD} =5.5V.

 $200\mu A$ (typ.) to $600\mu A$ (max) is added to the current of the differential receiver when the receiver is enabled.

The differential receiver is enabled by either of the following conditions :

- When the Neuron chip is in Run mode and the communication ports are in Differential mode.
- When the Neuron chip is in Sleep mode, the communication ports are in Differential mode, and the Comm Port Wakeup is not masked.

TOSHIBA TMPN3150B1AFG

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PACKAGE DIMENSONS

QFP64-P-1414-0.80C

